EUROPEAN PATENT OFFICE

Patent Abstracts of Japan

工程断面図(その1)

GeN

使起GaN

InGaN

GaN

303

302

301

304

303

302

302

301

PUBLICATION NUMBER

PUBLICATION DATE

2001342100

11-12-01

APPLICATION DATE

29-09-00

APPLICATION NUMBER

2000301301

APPLICANT: TOSHIBA CORP;

(b)

(a)

INVENTOR: ISHIKAWA MASAYUKI;

INT.CL.

C30B 29/38 C30B 25/18 H01L 33/00

TITLE

MANUFACTURING METHOD OF

SUBSTRATE FOR EPITAXIAL **GROWTH AND MANUFACTURING** METHOD OF SEMICONDUCTOR

DEVICE USING SUBSTRATE FOR THIS

EPITAXIAL GROWTH



ABSTRACT:

PROBLEM TO BE SOLVED: To efficiently and easily obtain a substrate for epitaxial growth of a GaN compound semiconductor monocrystal membrane which has little crystal defect and favorable surface morphology.

SOLUTION: This method comprises at least the steps of (a) epitaxially growing a first GaN compound semi conductor monocrystal membrane 303 on a bulk crystal substrate 301; (b) epitaxially growing a GaN compound semiconductor monocrystal membrane 304 containing In; (c) epitaxially growing a second GaN compound semiconductor monocrystal membrane 305; and separating a second GaN compound semiconductor monocrystal membrane 305 from the bulk crystal substrate 301 and making it the substrate for the epitaxial growth.

COPYRIGHT: (C)2001,JPO